

# Smart Highside Power Switch

## Features

- Load dump and reverse battery protection<sup>1)</sup>
- Clamp of negative voltage at output
- Short-circuit protection
- Current limitation
- Thermal shutdown
- Diagnostic feedback
- Open load detection in ON-state
- CMOS compatible input
- **Electrostatic discharge (ESD)** protection
- Loss of ground and loss of  $V_{bb}$  protection<sup>2)</sup>
- Overvoltage protection
- Undervoltage and overvoltage shutdown with auto-restart and hysteresis

## Application

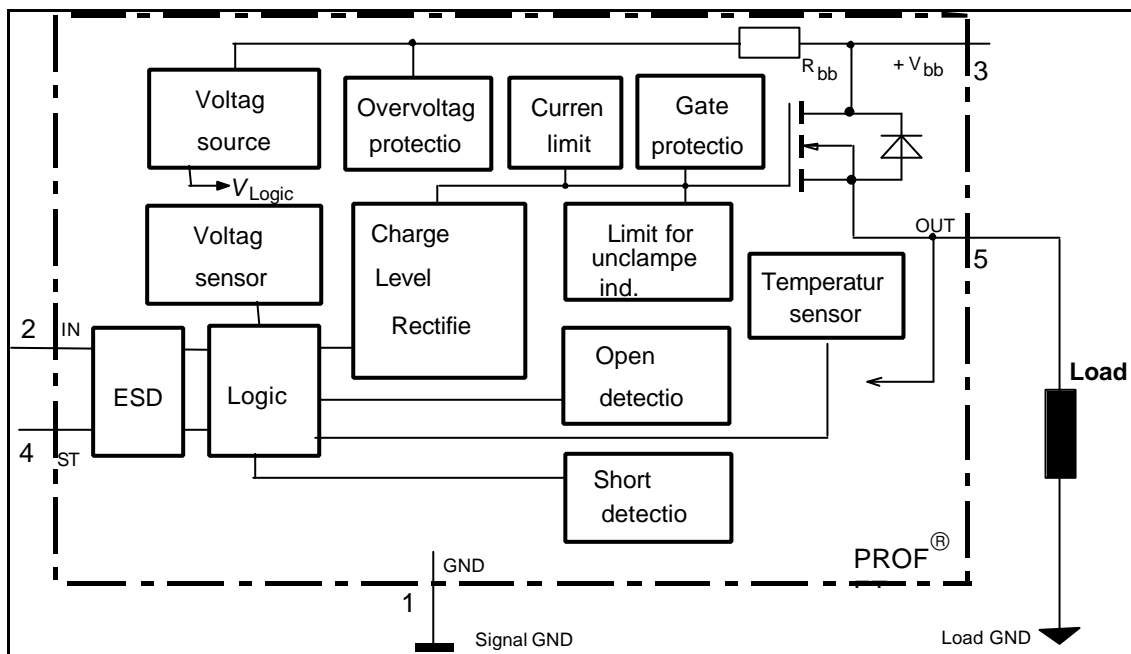
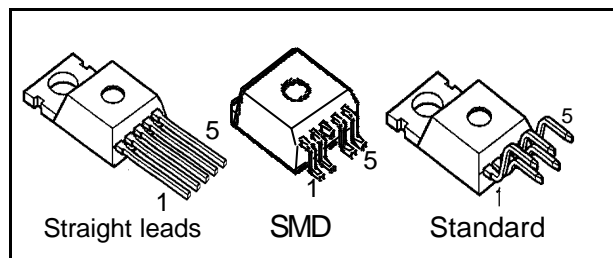
- $\mu$ C compatible power switch with diagnostic feedback for 12 V and 24 V DC grounded loads
- All types of resistive, inductive and capacitive loads
- Replaces electromechanical relays and discrete circuits

## General Description

N channel vertical power FET with charge pump, ground referenced CMOS compatible input and diagnostic feedback, integrated in Smart SIPMOS® chip on chip technology. Fully protected by embedded protection functions.

## Product Summary

|                                    |            |            |
|------------------------------------|------------|------------|
| $V_{Load\ dump}$                   | 80         | V          |
| $V_{bb} - V_{OUT}$ Avalanche Clamp | 58         | V          |
| $V_{bb}$ (operation)               | 4.5 ... 42 | V          |
| $V_{bb}$ (reverse)                 | -32        | V          |
| $R_{ON}$                           | 38         | m $\Omega$ |
| $I_L(SCp)$                         | 44         | A          |
| $I_L(SCr)$                         | 35         | A          |
| $I_L(ISO)$                         | 11         | A          |



1) No external components required, reverse load current limited by connected load.

2) Additional external diode required for charged inductive loads

| Pin | Symbol           |   | Function   |
|-----|------------------|---|--|
| 1   | GND              | - | Logic ground   |
| 2   | IN               | I | Input, activates the power switch in case of logical high signal |
| 3   | V <sub>bb</sub>  | + | Positive power supply voltage, the tab is shorted to this pin    |
| 4   | ST               | S | Diagnostic feedback, low on failure                              |
| 5   | OUT<br>(Load, L) | O | Output to the load   |

**Maximum Ratings** at  $T_j = 25\text{ °C}$  unless otherwise specified

| Parameter  | Symbol   | Values                   | Unit                 |     |
|--|--|--------------------------|----------------------|-----|
| Supply voltage (overvoltage protection see page 3)   | $V_{bb}$   | 63                       | V                    |     |
| Load dump protection $V_{LoadDump} = U_A + V_S$ , $U_A = 13.5\text{ V}$<br>$R_I = 2\ \Omega$ , $R_L = 1.1\ \Omega$ , $t_d = 200\text{ ms}$ , IN= low or high | $V_S^{3)}$   | 66.5                     | V                    |     |
| Load current (Short-circuit current, see page 4)   | $I_L$  | self-limited             | A                    |     |
| Operating temperature range  | $T_j$  | -40 ... +150             | °C                   |     |
| Storage temperature range  | $T_{stg}$  | -55 ... +150             |                      |     |
| Power dissipation (DC)   | $P_{tot}$  | 125                      | W                    |     |
| Inductive load switch-off energy dissipation,<br>single pulse $T_j = 150\text{ °C}$ :  | $E_{AS}$   | 1.7                      | J                    |     |
| Electrostatic discharge capability (ESD)<br>(Human Body Model)   | $V_{ESD}$  | 2.0                      | kV                   |     |
| Input voltage (DC)   | $V_{IN}$   | -0.5 ... +6              | V                    |     |
| Current through input pin (DC)   | $I_{IN}$   | ±5.0                     | mA                   |     |
| Current through status pin (DC)  | $I_{ST}$   | ±5.0                     |                      |     |
| see internal circuit diagrams page 6...  |  |                          |                      |     |
| Thermal resistance   | chip - case:<br>junction - ambient (free air):<br>SMD version, device on pcb <sup>4)</sup> : | $R_{thJC}$<br>$R_{thJA}$ | ≤ 1<br>≤ 75<br>≤ tbd | K/W |

3)  $V_S$  is setup without DUT connected to the generator per ISO 7637-1 and DIN 40839

4) Device on 50mm\*50mm\*1.5mm epoxy PCB FR4 with 6cm<sup>2</sup> (one layer, 70µm thick) copper area for  $V_{bb}$  connection. PCB is vertical without blown air.

## Electrical Characteristics

| Parameter and Conditions<br>at $T_j = 25\text{ °C}$ , $V_{bb} = 12\text{ V}$ unless otherwise specified | Symbol | Values |     |     | Unit |
|---|--------|--------|-----|-----|------|
|   |        | min    | typ | max |      |

### Load Switching Capabilities and Characteristics

|   |                  |     |          |          |           |
|---|------------------|-----|----------|----------|-----------|
| On-state resistance (pin 3 to 5)<br>$I_L = 2\text{ A}$<br>$T_j = 25\text{ °C}$ :<br>$T_j = 150\text{ °C}$ :                             | $R_{ON}$         | --  | 30<br>55 | 38<br>70 | $m\Omega$ |
| Nominal load current (pin 3 to 5)<br>ISO Proposal: $V_{ON} = 0.5\text{ V}$ , $T_C = 85\text{ °C}$                                       | $I_{L(ISO)}$     | 9   | 11       | --       | A         |
| Output current (pin 5) while GND disconnected or<br>GND pulled up, $V_{IN} = 0$ , see diagram page 7,<br>$T_j = -40\dots+150\text{ °C}$ | $I_{L(GNDhigh)}$ | --  | --       | 1        | mA        |
| Turn-on time to 90% $V_{OUT}$ :   | $t_{on}$         | 50  | 160      | 300      | $\mu s$   |
| Turn-off time to 10% $V_{OUT}$ :  | $t_{off}$        | 10  | --       | 80       |           |
| $R_L = 12\ \Omega$ , $T_j = -40\dots+150\text{ °C}$   |                  |     |          |          |           |
| Slew rate on<br>10 to 30% $V_{OUT}$ , $R_L = 12\ \Omega$ , $T_j = -40\dots+150\text{ °C}$   | $dV/dt_{on}$     | 0.4 | --       | 2.5      | $V/\mu s$ |
| Slew rate off<br>70 to 40% $V_{OUT}$ , $R_L = 12\ \Omega$ , $T_j = -40\dots+150\text{ °C}$  | $-dV/dt_{off}$   | 1   | --       | 5        | $V/\mu s$ |

### Operating Parameters

|   |                        |          |          |          |         |
|---|------------------------|----------|----------|----------|---------|
| Operating voltage <sup>5)</sup><br>$T_j = -40\dots+150\text{ °C}$ :   | $V_{bb(on)}$           | 4.5      | --       | 42       | V       |
| Undervoltage shutdown<br>$T_j = -40\dots+150\text{ °C}$ :   | $V_{bb(under)}$        | 2.4      | --       | 4.5      | V       |
| Undervoltage restart<br>$T_j = -40\dots+150\text{ °C}$ :  | $V_{bb(u\ rst)}$       | --       | --       | 4.5      | V       |
| Undervoltage restart of charge pump<br>see diagram page 12<br>$T_j = -40\dots+150\text{ °C}$ :                                | $V_{bb(ucp)}$          | --       | 6.5      | 7.5      | V       |
| Undervoltage hysteresis<br>$\Delta V_{bb(under)} = V_{bb(u\ rst)} - V_{bb(under)}$  | $\Delta V_{bb(under)}$ | --       | 0.2      | --       | V       |
| Overvoltage shutdown<br>$T_j = -40\dots+150\text{ °C}$ :  | $V_{bb(over)}$         | 42       | --       | 52       | V       |
| Overvoltage restart<br>$T_j = -40\dots+150\text{ °C}$ :   | $V_{bb(o\ rst)}$       | 42       | --       | --       | V       |
| Overvoltage hysteresis<br>$T_j = -40\dots+150\text{ °C}$ :  | $\Delta V_{bb(over)}$  | --       | 0.2      | --       | V       |
| Overvoltage protection <sup>6)</sup><br>$I_{bb} = 40\text{ mA}$<br>$T_j = -40\text{ °C}$ :<br>$T_j = 25\dots+150\text{ °C}$ : | $V_{bb(AZ)}$           | 60<br>63 | --<br>67 | --       | V       |
| Standby current (pin 3)<br>$V_{IN} = 0$ , $I_{ST} = 0$ ,<br>$T_j = -40\dots+25\text{ °C}$ :<br>$T_j = 150\text{ °C}$ :        | $I_{bb(off)}$          | --<br>-- | 12<br>18 | 25<br>60 | $\mu A$ |
| Leakage output current (included in $I_{bb(off)}$ )<br>$V_{IN} = 0$   | $I_{L(off)}$           | --       | 6        | --       | $\mu A$ |
| Operating current (Pin 1) <sup>7)</sup> , $V_{IN} = 5\text{ V}$   | $I_{GND}$              | --       | 1.1      | --       | mA      |

<sup>5)</sup> At supply voltage increase up to  $V_{bb} = 6.5\text{ V}$  typ without charge pump,  $V_{OUT} \approx V_{bb} - 2\text{ V}$

<sup>6)</sup> see also  $V_{ON(CL)}$  in table of protection functions and circuit diagram page 7. Measured without load.

**Protection Functions**

|  |              |     |     |     |                  |
|--|--------------|-----|-----|-----|------------------|
| Initial peak short circuit current limit (pin 3 to 5) <sup>8)</sup> ,<br>( max 400 $\mu$ s if $V_{ON} > V_{ON(SC)}$ )                          | $I_{L(SCp)}$ |     |     |     |                  |
| $T_j = -40^\circ\text{C}$ :  |              | --  | --  | 74  | A                |
| $T_j = 25^\circ\text{C}$ :   |              | --  | 44  | --  |                  |
| $T_j = +150^\circ\text{C}$ :   |              | 24  | --  | --  |                  |
| Repetitive short circuit current limit<br>$T_j = T_{jt}$ (see timing diagrams, page 10)  | $I_{L(SCr)}$ | 22  | 35  | --  | A                |
| Short circuit shutdown delay after input pos. slope<br>$V_{ON} > V_{ON(SC)}$ ,<br>min value valid only, if input "low" time exceeds 30 $\mu$ s | $t_{d(SC)}$  | 80  | --  | 400 | $\mu$ s          |
| Output clamp (inductive load switch off)<br>at $V_{OUT} = V_{bb} - V_{ON(CL)}$ , $I_L = 30$ mA   | $V_{ON(CL)}$ | --  | 58  | --  | V                |
| Short circuit shutdown detection voltage<br>(pin 3 to 5)   | $V_{ON(SC)}$ | --  | 8.3 | --  | V                |
| Thermal overload trip temperature  | $T_{jt}$     | 150 | --  | --  | $^\circ\text{C}$ |
| Thermal hysteresis   | $DT_{jt}$    | --  | 10  | --  | K                |
| Inductive load switch-off energy dissipation <sup>9)</sup> ,<br>$T_{j\text{Start}} = 150^\circ\text{C}$ , single pulse                         | $E_{AS}$     | --  | --  | 1.7 | J                |
| $V_{bb} = 12$ V:   | $E_{Load12}$ |     |     | 1.3 |                  |
| $V_{bb} = 24$ V:   | $E_{Load24}$ |     |     | 1.0 |                  |
| Reverse battery (pin 3 to 1) <sup>10)</sup>  | $-V_{bb}$    | --  | --  | 32  | V                |
| Integrated resistor in $V_{bb}$ line   | $R_{bb}$     | --  | 120 | --  | $\Omega$         |

**Diagnostic Characteristics**

|   |  |           |        |          |            |    |
|---|--|-----------|--------|----------|------------|----|
| Open load detection current<br>(on-condition) | $T_j = -40^\circ\text{C}$ :<br>$T_j = 25..150^\circ\text{C}$ : | $I_L(OL)$ | 2<br>2 | --<br>-- | 900<br>750 | mA |
|---|--|-----------|--------|----------|------------|----|

7) Add  $I_{ST}$ , if  $I_{ST} > 0$ , add  $I_{IN}$ , if  $V_{IN} > 5.5$  V



8) Short circuit current limit for max. duration of 400  $\mu$ s, prior to shutdown (see  $t_{d(SC)}$  page 4)

9) While demagnetizing load inductance, dissipated energy in PROFET is  $E_{AS} = \int V_{ON(CL)} \cdot i_L(t) dt$ , approx.

$$E_{AS} = \frac{1}{2} \cdot L \cdot I_L^2 \cdot \left( \frac{V_{ON(CL)}}{V_{ON(CL)} - V_{bb}} \right), \text{ see diagram page 8}$$

10) Reverse load current (through intrinsic drain-source diode) is normally limited by the connected load. Reverse current  $I_{GND}$  of  $\approx 0.3$  A at  $V_{bb} = -32$  V through the logic heats up the device. Time allowed under these condition is dependent on the size of the heatsink. Reverse  $I_{GND}$  can be reduced by an additional external GND-resistor (150  $\Omega$ ). Input and Status currents have to be limited (see max. ratings page 2 and circuit page 7).

**Input and Status Feedback<sup>11)</sup>**

|  |   |                      |     |     |      |               |
|--|---|----------------------|-----|-----|------|---------------|
| Input turn-on threshold voltage                              |  | $V_{IN(T+)}$         | 1.5 | --  | 2.4  | V             |
| Input turn-off threshold voltage                             |  | $V_{IN(T-)}$         | 1.0 | --  | --   | V             |
| Input threshold hysteresis                                   |   | $\Delta V_{IN(T)}$   | --  | 0.5 | --   | V             |
| Off state input current (pin 2)                              | $V_{IN} = 0.4 \text{ V}$ :  | $I_{IN(off)}$        | 1   | --  | 30   | $\mu\text{A}$ |
| On state input current (pin 2)                               | $V_{IN} = 3.5 \text{ V}$ :  | $I_{IN(on)}$         | 10  | 25  | 50   | $\mu\text{A}$ |
| Status invalid after positive input slope<br>(short circuit) | $T_j = -40 \dots +150^\circ\text{C}$ :  | $t_{d(ST\ SC)}$      | 80  | 200 | 400  | $\mu\text{s}$ |
| Status invalid after positive input slope<br>(open load)     | $T_j = -40 \dots +150^\circ\text{C}$ :  | $t_{d(ST)}$          | 350 | --  | 1600 | $\mu\text{s}$ |
| Status output (CMOS)   | $T_j = -40\dots+150^\circ\text{C}$ , $I_{ST} = -50 \mu\text{A}$ :                 | $V_{ST(high)}^{12)}$ | 4.4 | 5.1 | 6.5  | V             |
|  | $T_j = -40\dots+150^\circ\text{C}$ , $I_{ST} = +1.6 \text{ mA}$ :                 | $V_{ST(low)}$        | --  | --  | 0.4  |               |
| Max. status current for<br>valid status output,              | current source (out):   | $-I_{ST}$            | --  | --  | 0.25 | mA            |
| $T_j = -40\dots+150^\circ\text{C}$                           | current sink (in) :   | $+I_{ST}^{13)}$      | --  | --  | 1.6  |               |

11) If a ground resistor  $R_{GND}$  is used, add the voltage drop across this resistor.

12)  $V_{St\ high} \approx V_{bb}$  during undervoltage shutdown

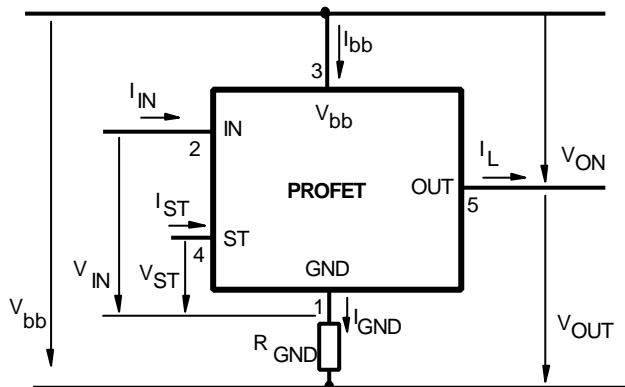
13) No current sink capability during undervoltage shutdown

**Truth Table**

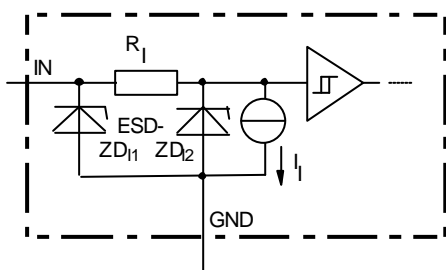
|                                  | Input-level | Output level | Status               |                      |                  |
|----------------------------------|-------------|--------------|----------------------|----------------------|------------------|
|                                  |             |              | 432 D2               | 432 E2/F2            | 432 I2           |
| Normal operation                 | L           | L            | H                    | H                    | H                |
|                                  | H           | H            | H                    | H                    | H                |
| Open load                        | L           | 14)          | H                    | H                    | L                |
|                                  | H           | H            | L                    | L                    | H                |
| Short circuit to GND             | L           | L            | H                    | H                    | H                |
|                                  | H           | L            | L                    | L                    | L                |
| Short circuit to V <sub>bb</sub> | L           | H            | H                    | H                    | L                |
|                                  | H           | H            | H (L <sup>15</sup> ) | H (L <sup>15</sup> ) | H                |
| Overtemperature                  | L           | L            | L                    | L                    | L                |
|                                  | H           | L            | L                    | L                    | L                |
| Undervoltage                     | L           | L            | L <sup>16)</sup>     | H                    | L <sup>16)</sup> |
|                                  | H           | L            | L <sup>16)</sup>     | H                    | L <sup>16)</sup> |
| Overvoltage                      | L           | L            | L                    | H                    | L                |
|                                  | H           | L            | L                    | H                    | L                |

L = "Low" Level  
H = "High" Level

**Terms**

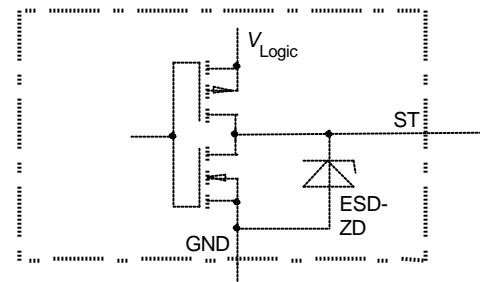


**Input circuit (ESD protection)**



ZD1 6.1 V typ., ESD zener diodes are not designed for continuous current

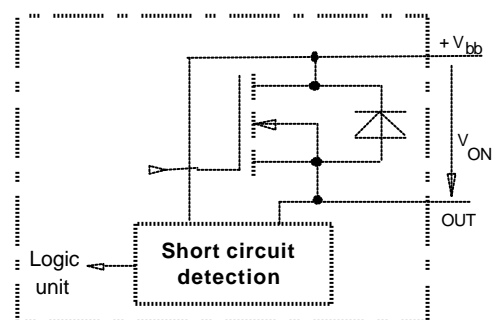
**Status output**



Zener diode: 6.1 V typ., max 5 mA, V<sub>Logic</sub> 5 V typ, ESD zener diodes are not designed for continuous current

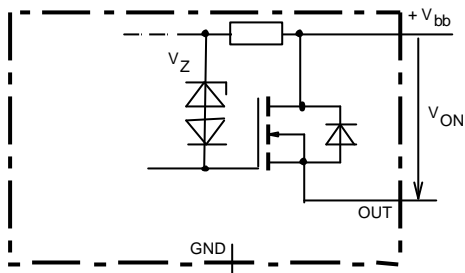
**Short Circuit detection**

Fault Condition: V<sub>ON</sub> > 8.3 V typ.; IN high



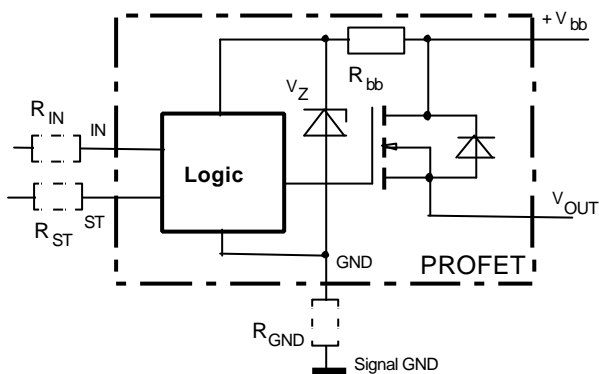
- 14) Power Transistor off, high impedance
- 15) Low resistance short V<sub>bb</sub> to output may be detected by no-load-detection
- 16) No current sink capability during undervoltage shutdown

**Inductive and overvoltage output clamp**



$V_{ON}$  clamped to 58 V typ.

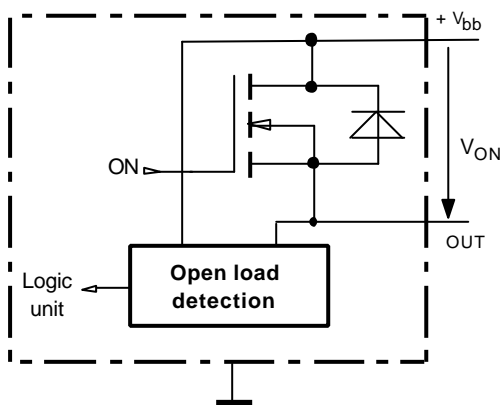
**Overvolt. and reverse batt. protection**



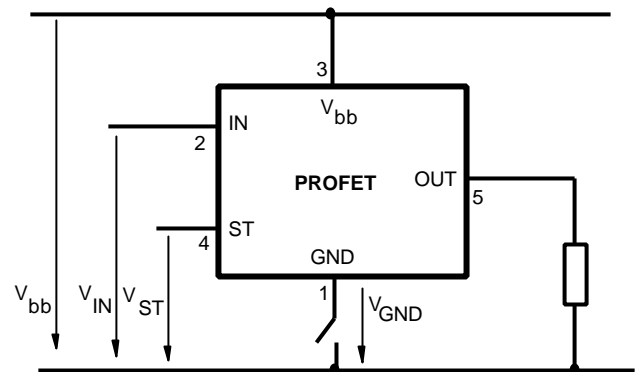
$R_{bb} = 120 \Omega$  typ.,  $V_Z + R_{bb} * 40 \text{ mA} = 67 \text{ V}$  typ., add  $R_{GND}$ ,  $R_{IN}$ ,  $R_{ST}$  for extended protection

**Open-load detection**

ON-state diagnostic condition:  $V_{ON} < R_{ON} * I_{L(OL)}$ ; IN high

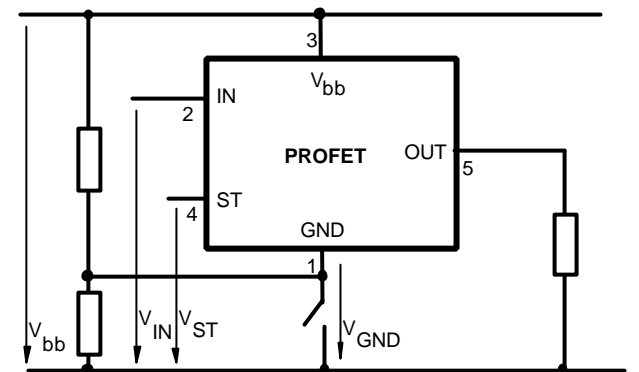


**GND disconnect**



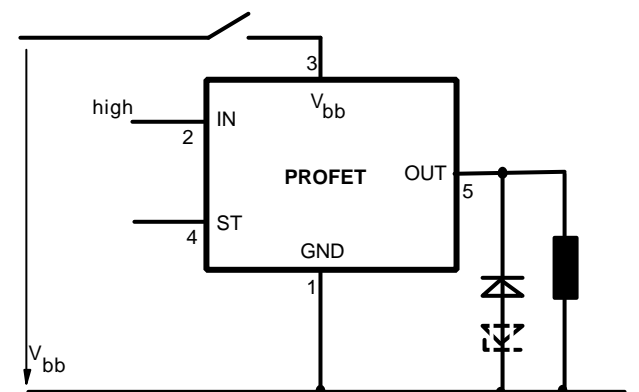
Any kind of load. In case of Input=high is  $V_{OUT} \approx V_{IN} - V_{IN(T+)}$ . Due to  $V_{GND} > 0$ , no  $V_{ST} = \text{low}$  signal available.

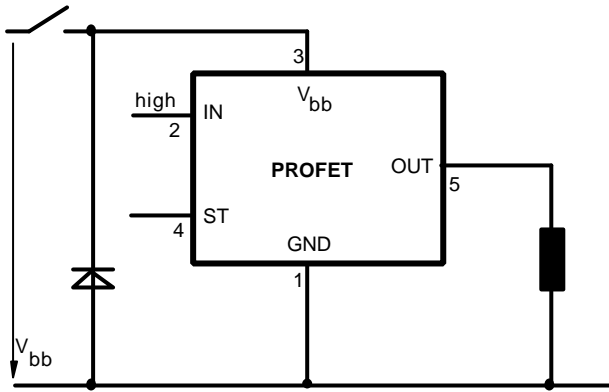
**GND disconnect with GND pull up**



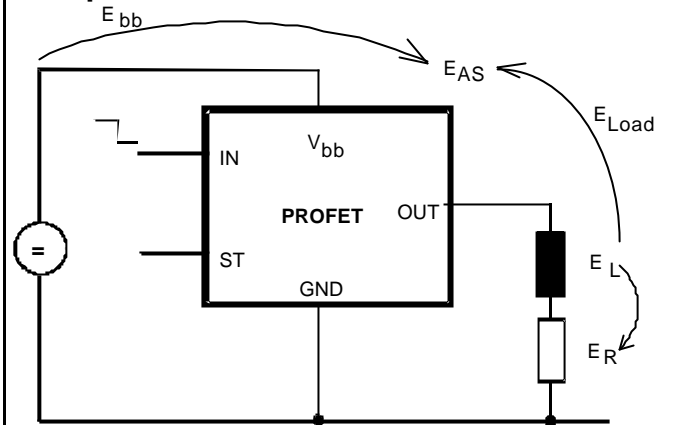
Any kind of load. If  $V_{GND} > V_{IN} - V_{IN(T+)}$  device stays off. Due to  $V_{GND} > 0$ , no  $V_{ST} = \text{low}$  signal available.

**Vbb disconnect with charged inductive load**





### Inductive Load switch-off energy dissipation



Energy dissipated in PROFET  $E_{AS} = E_{bb} + E_L - E_R$ .  
 $E_{Load} < E_L$ ,  $E_L = \frac{1}{2} * L * I_L^2$



## Options Overview

**all versions: High-side switch, Input protection, ESD protection, load dump and reverse battery protection , protection against loss of ground**

| Type  | BTS | 432D2       | 432E2       | 432F2       | 432I2    |
|---|-----|-------------|-------------|-------------|----------|
| Logic version   |     | <b>D</b>    | <b>E</b>    | <b>F</b>    | <b>I</b> |
| Overtemperature protection<br>$T_j > 150\text{ °C}$ , latch function <sup>17)18)</sup><br>$T_j > 150\text{ °C}$ , with auto-restart on cooling      |     | <b>X</b>    |             | <b>X</b>    | <b>X</b> |
| Short-circuit to GND protection<br>switches off when $V_{ON} > 8.3\text{ V typ. }^{17)}$<br>(when first turned on after approx. 200 $\mu\text{s}$ ) |     | <b>X</b>    | <b>X</b>    | <b>X</b>    | <b>X</b> |
| Open load detection<br>in OFF-state with sensing current 30 $\mu\text{A typ.}$<br>in ON-state with sensing voltage drop across<br>power transistor  |     | <b>X</b>    | <b>X</b>    | <b>X</b>    | <b>X</b> |
| Undervoltage shutdown with auto restart   |     | <b>X</b>    | <b>X</b>    | <b>X</b>    | <b>X</b> |
| Overvoltage shutdown with auto restart  |     | <b>X</b>    | <b>X</b>    | <b>X</b>    | <b>X</b> |
| Status feedback for   |     |             |             |             |          |
| overtemperature   |     | <b>X</b>    | <b>X</b>    | <b>X</b>    | <b>X</b> |
| short circuit to GND  |     | <b>X</b>    | <b>X</b>    | <b>X</b>    | <b>X</b> |
| short to $V_{bb}$   |     | <b>_19)</b> | <b>_19)</b> | <b>_19)</b> | <b>X</b> |
| open load   |     | <b>X</b>    | <b>X</b>    | <b>X</b>    | <b>X</b> |
| undervoltage  |     | <b>X</b>    | -           | -           | <b>X</b> |
| overvoltage   |     | <b>X</b>    | -           | -           | <b>X</b> |
| Status output type  |     |             |             |             |          |
| CMOS  |     | <b>X</b>    |             |             | <b>X</b> |
| Open drain  |     |             | <b>X</b>    | <b>X</b>    |          |
| Output negative voltage transient limit<br>(fast inductive load switch off)<br>to $V_{bb} - V_{ON(CL)}$   |     | <b>X</b>    | <b>X</b>    | <b>X</b>    | <b>X</b> |
| Load current limit  |     |             |             |             |          |
| high level (can handle loads with high inrush currents)   |     | <b>X</b>    | <b>X</b>    |             |          |
| medium level  |     |             |             |             | <b>X</b> |
| low level (better protection of application)  |     |             |             | <b>X</b>    |          |

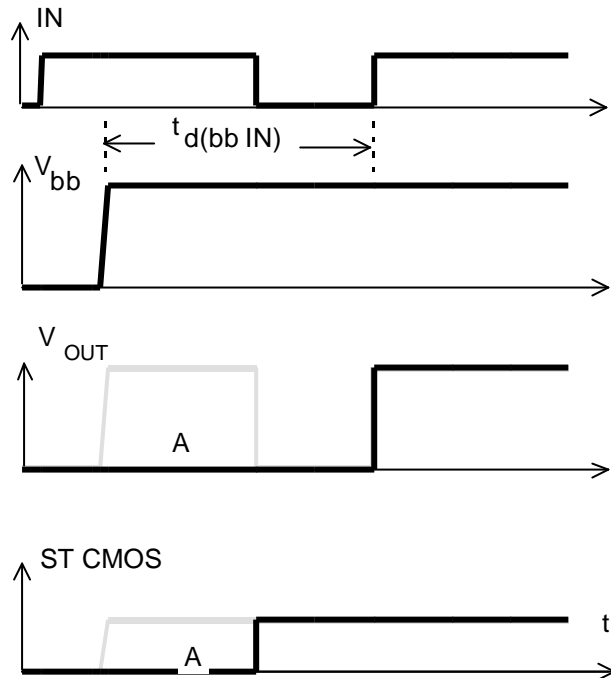
<sup>17)</sup> Latch except when  $V_{bb} - V_{OUT} < V_{ON(SC)}$  after shutdown. In most cases  $V_{OUT} = 0\text{ V}$  after shutdown ( $V_{OUT} \neq 0\text{ V}$  only if forced externally). So the device remains latched unless  $V_{bb} < V_{ON(SC)}$  (see page 4). No latch between turn on and  $t_{d(SC)}$ .

<sup>18)</sup> With latch function. Reseted by a) Input low, b) Undervoltage, c) Overvoltage

<sup>19)</sup> Low resistance short  $V_{bb}$  to output may be detected by no-load-detection

## Timing diagrams

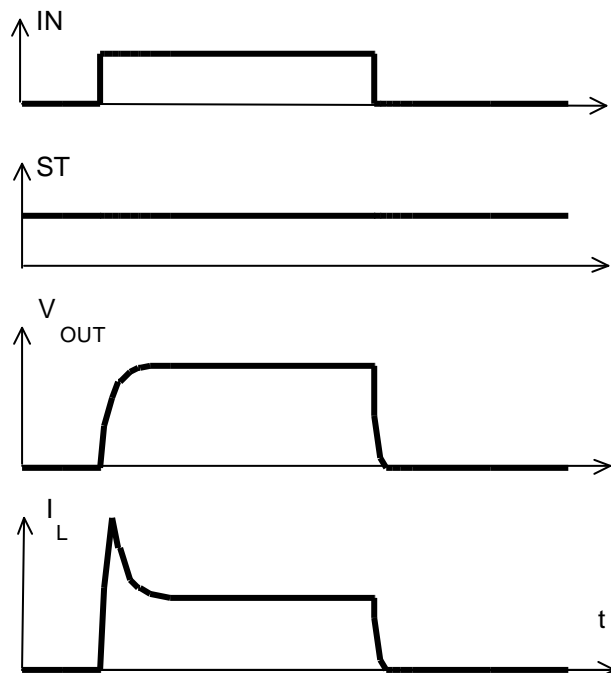
**Figure 1a:**  $V_{bb}$  turn on:



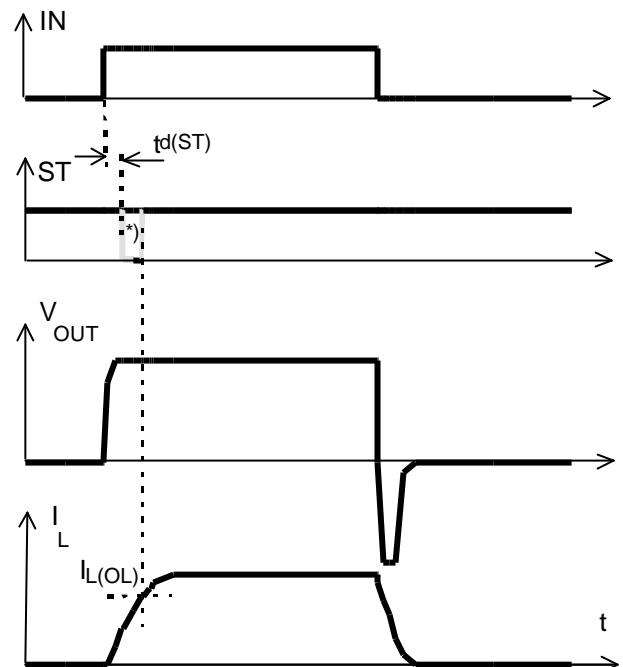
in case of too early  $V_{IN}$ =high the device may not turn on (curve A)

$t_{d(bb\ IN)}$  approx. 150  $\mu$ s

**Figure 2a:** Switching a lamp,

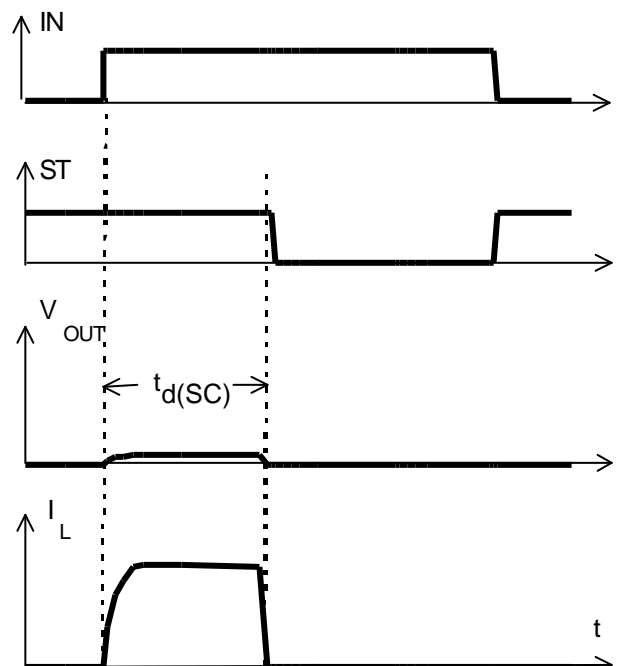


**Figure 2b:** Switching an inductive load

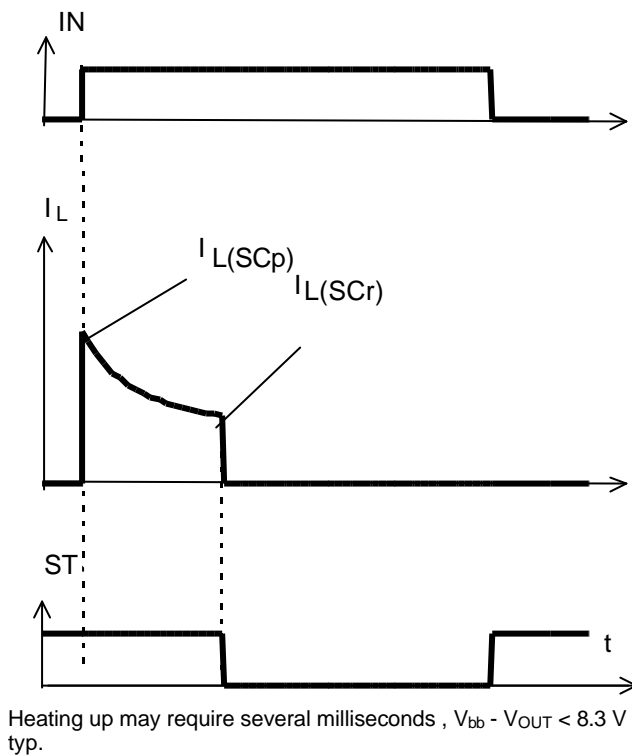
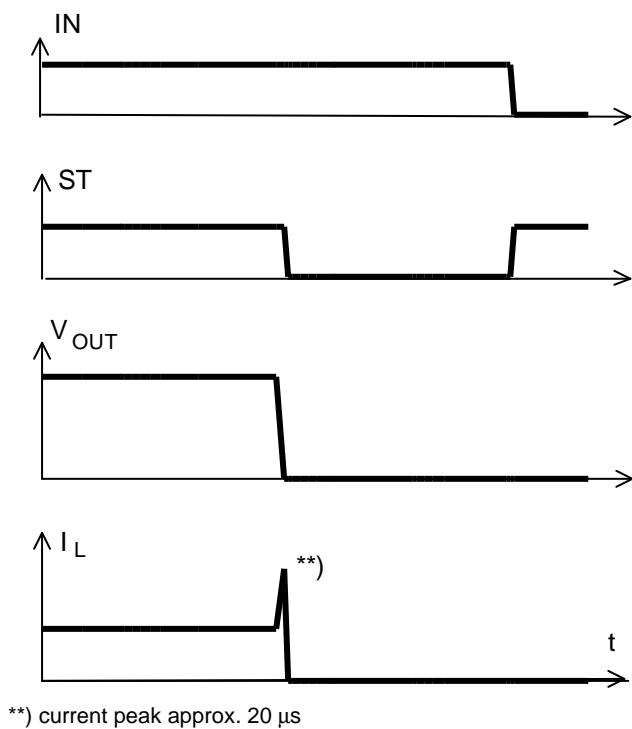


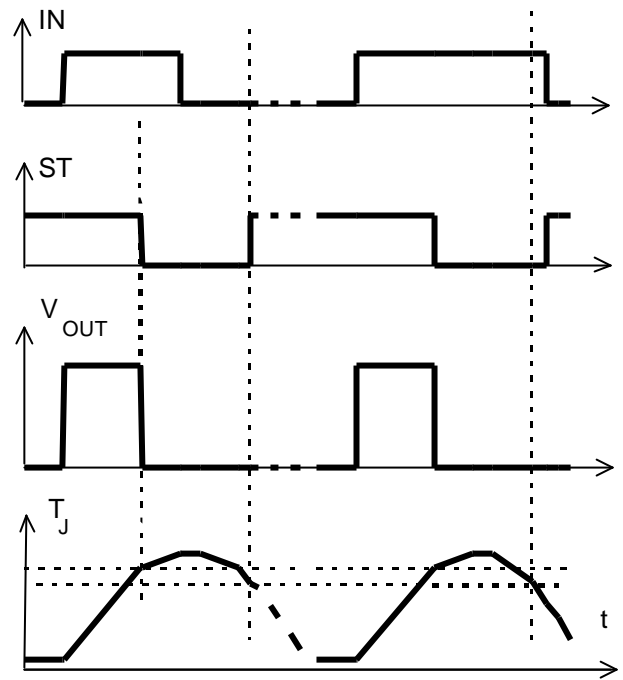
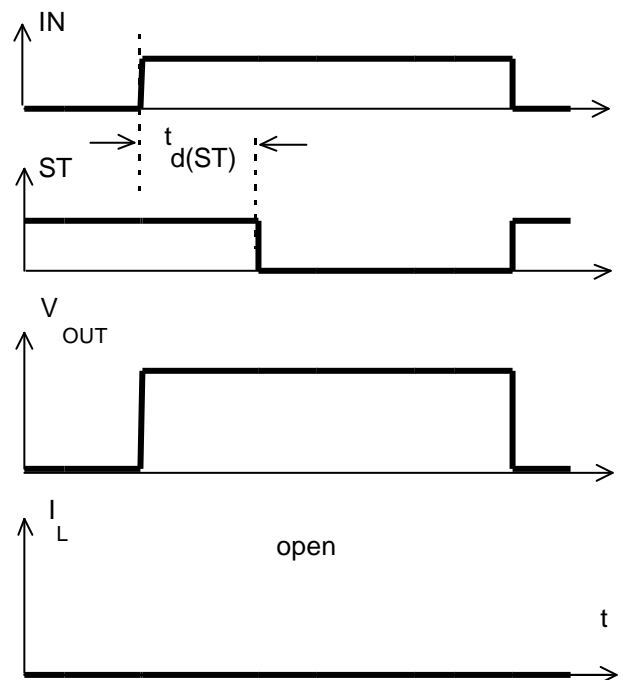
\*) if the time constant of load is too large, open-load-status may occur

**Figure 3a:** Turn on into short circuit,

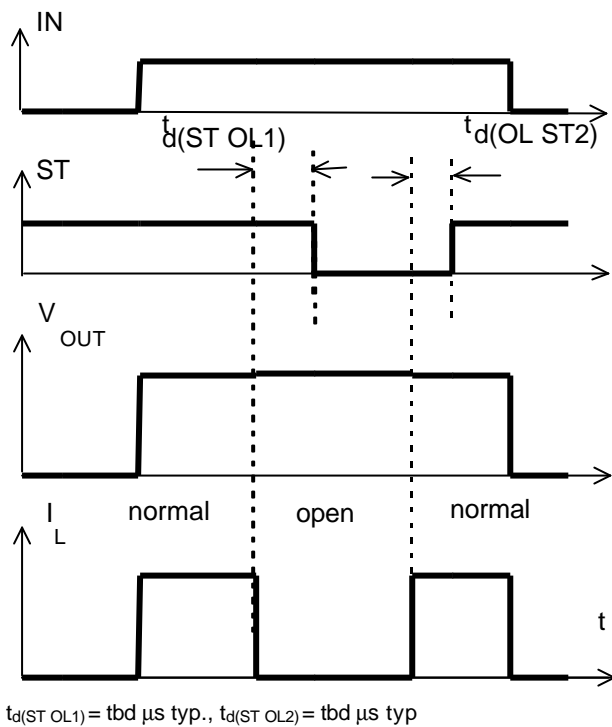


$t_{d(SC)}$  approx. 200 $\mu$ s if  $V_{bb} - V_{OUT} > 8.3$  V typ.

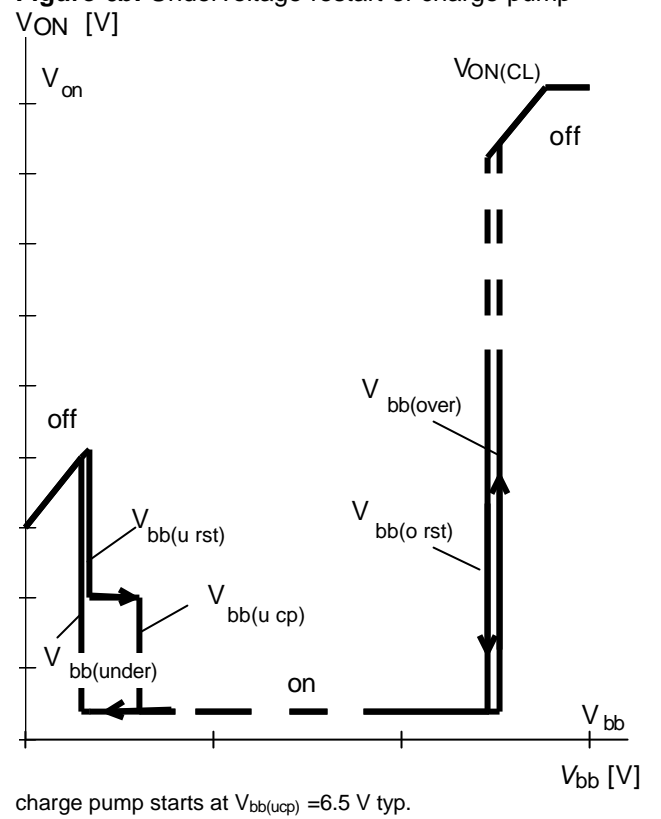
**Figure 3b: Turn on into overload,**

**Figure 3c: Short circuit while on:**

**Figure 4a: Overtemperature,**

 Reset if (IN=low) and ( $T_j < T_{jt}$ )

 \*) ST goes high, when  $V_{IN} = \text{low}$  and  $T_j < T_{jt}$ 
**Figure 5a: Open load: detection in ON-state, turn on/off to open load**


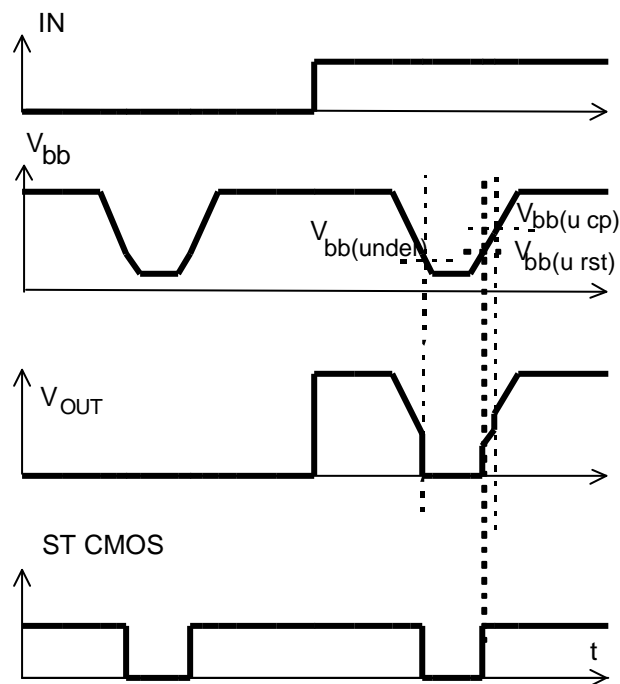
**Figure 5b:** Open load: detection in ON-state, open load occurs in on-state



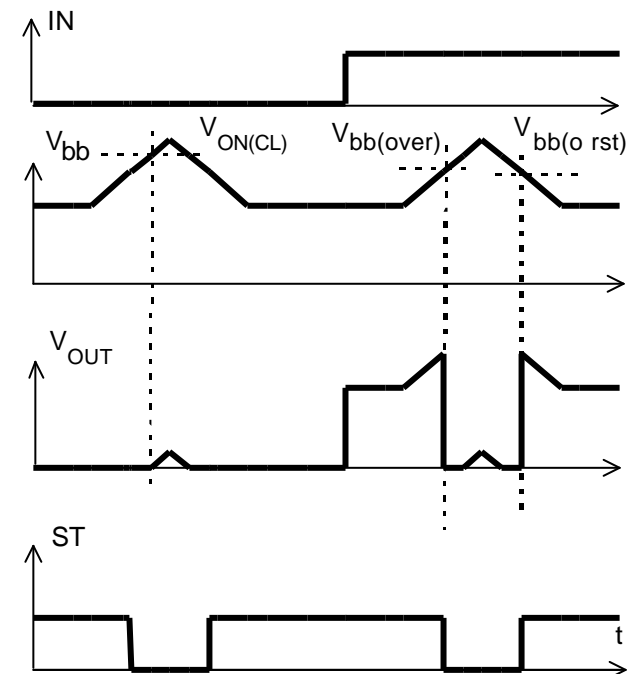
**Figure 6b:** Undervoltage restart of charge pump



**Figure 6a:** Undervoltage:



**Figure 7a:** Overvoltage:

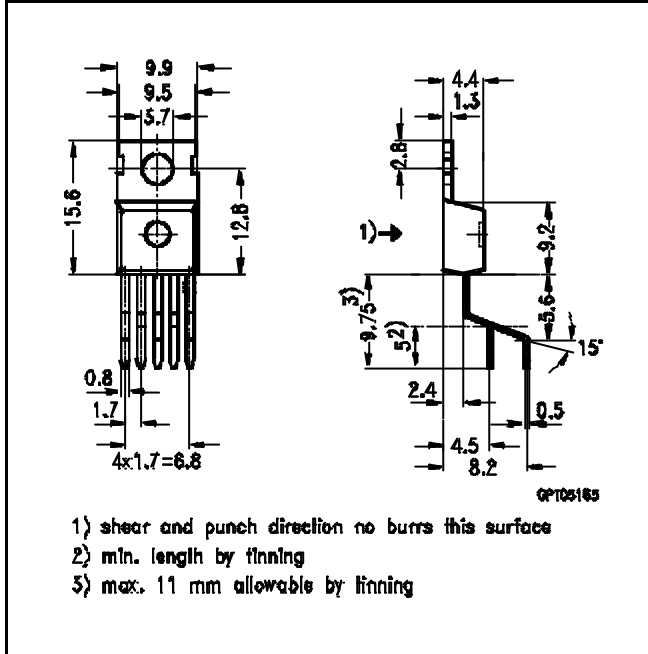


## Package and Ordering Code

All dimensions in mm

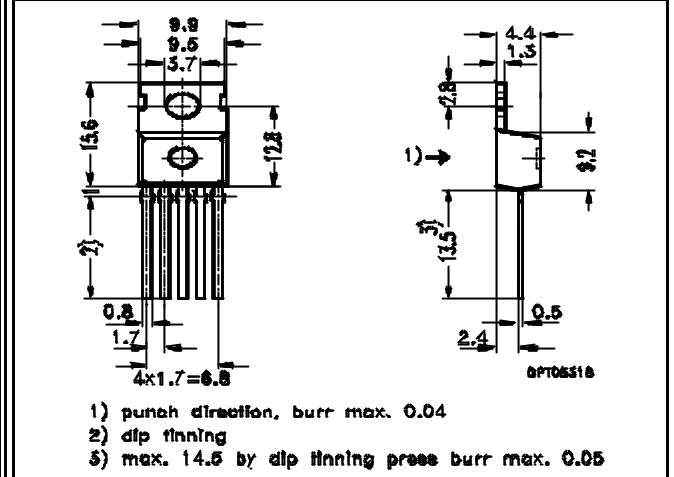
**Standard TO-220AB/5** Ordering code

|            |                 |
|------------|-----------------|
| BTS 432 D2 | Q67060-S6201-A2 |
|------------|-----------------|



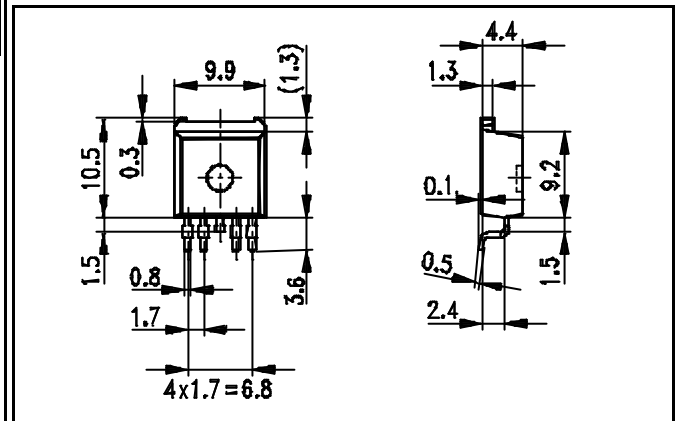
**TO-220AB/5, Option E3043** Ordering code

|                  |                 |
|------------------|-----------------|
| BTS 432 D2 E3043 | Q67060-S6201-A4 |
|------------------|-----------------|



**SMD TO-220AB/5, Opt. E3062** Ordering code

|                 |                      |
|-----------------|----------------------|
| BTS432D2 E3062A | T&R: Q67060-S6201-A5 |
|-----------------|----------------------|



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